

Fig. 2

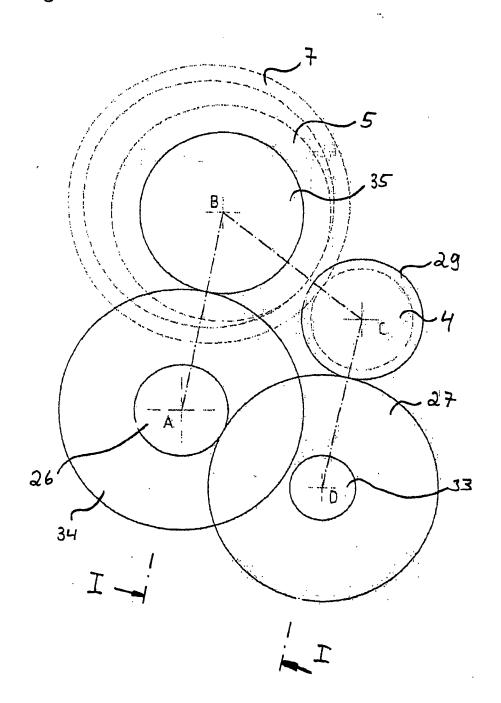
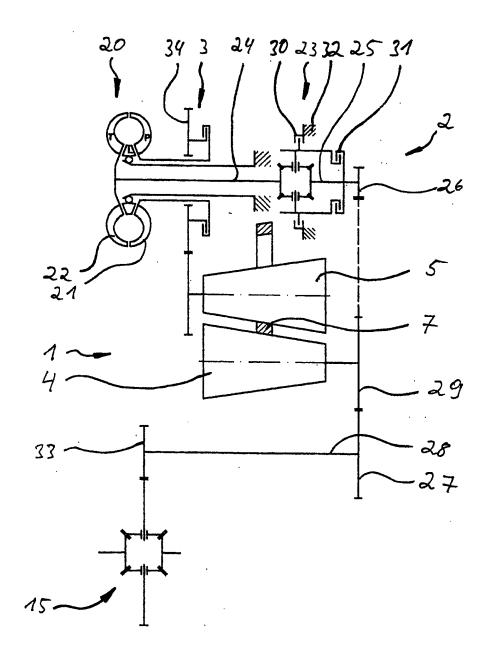


Fig. 3



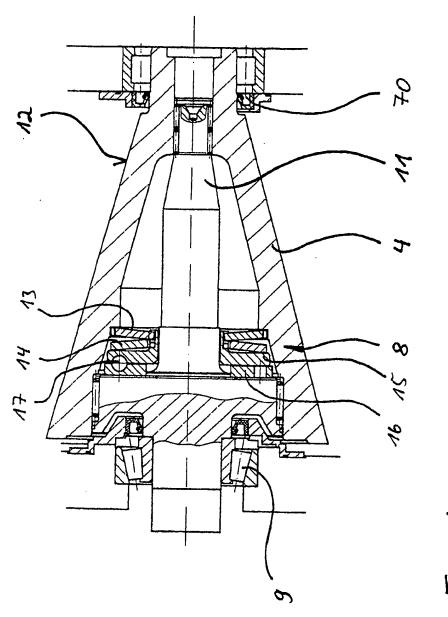
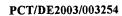


Fig. 4



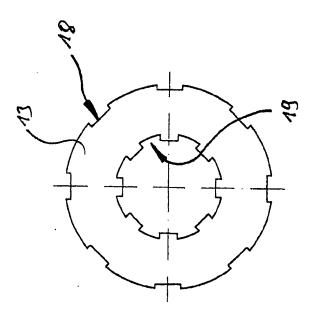
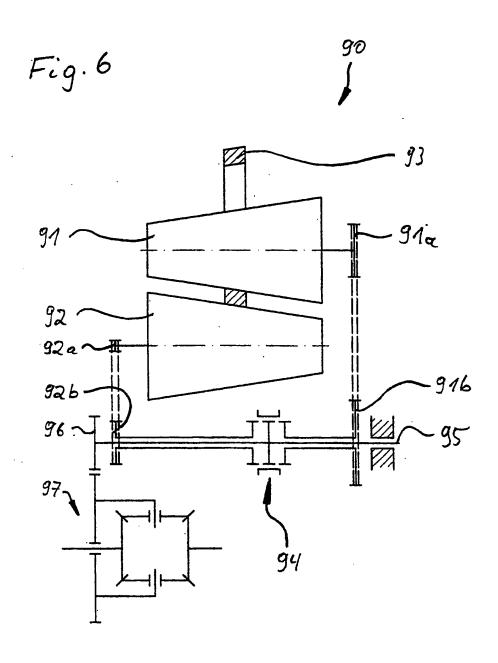


Fig. S



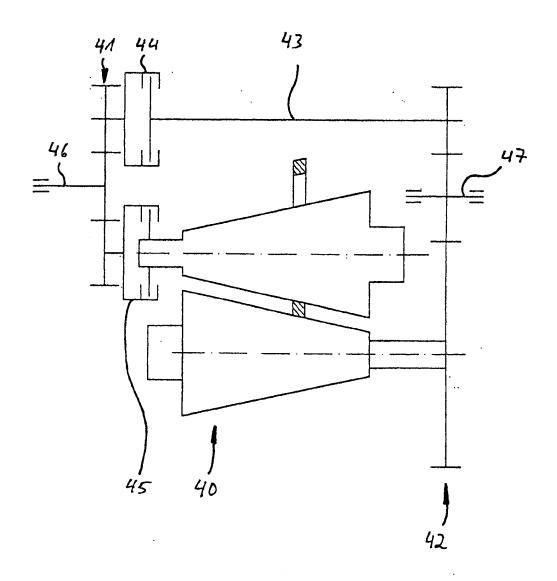
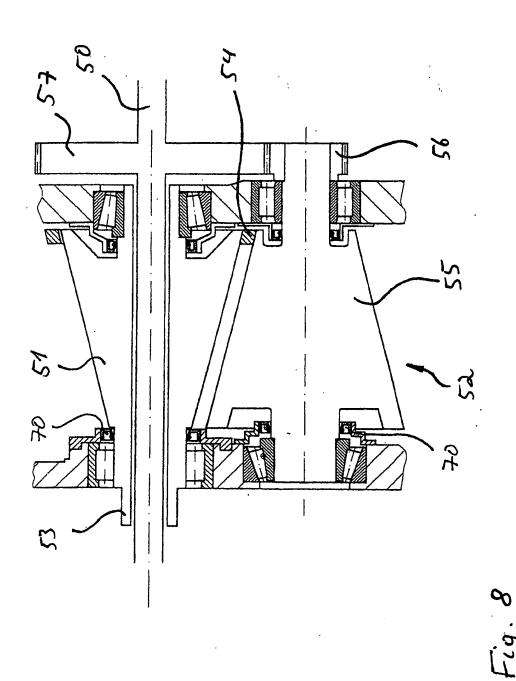
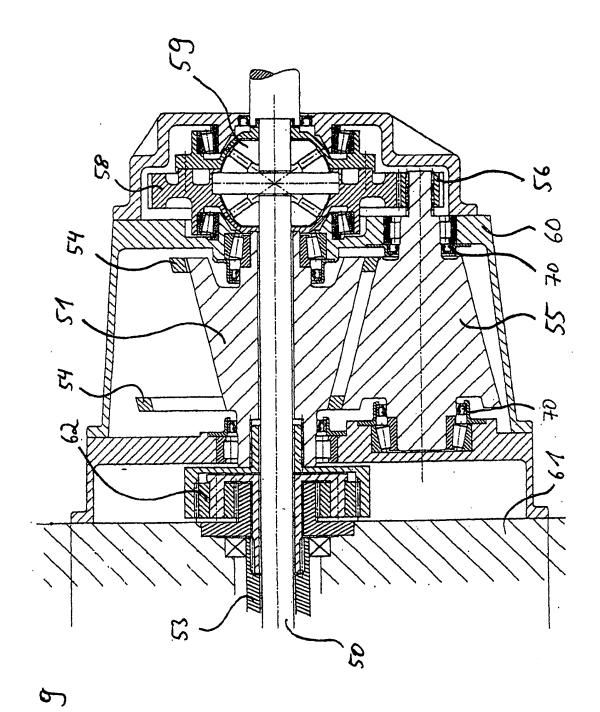


Fig.7





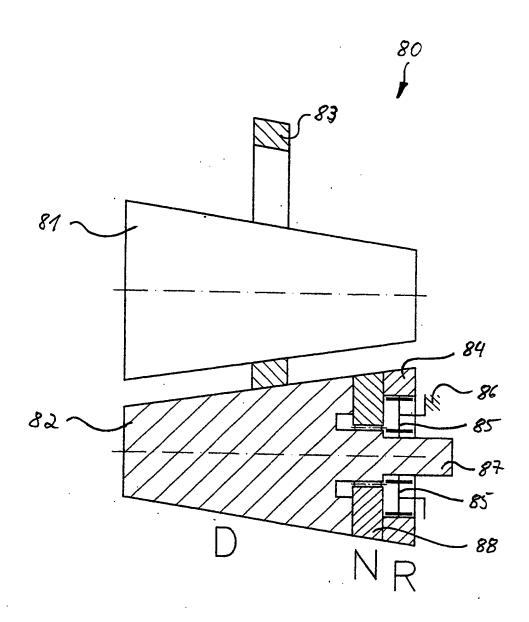
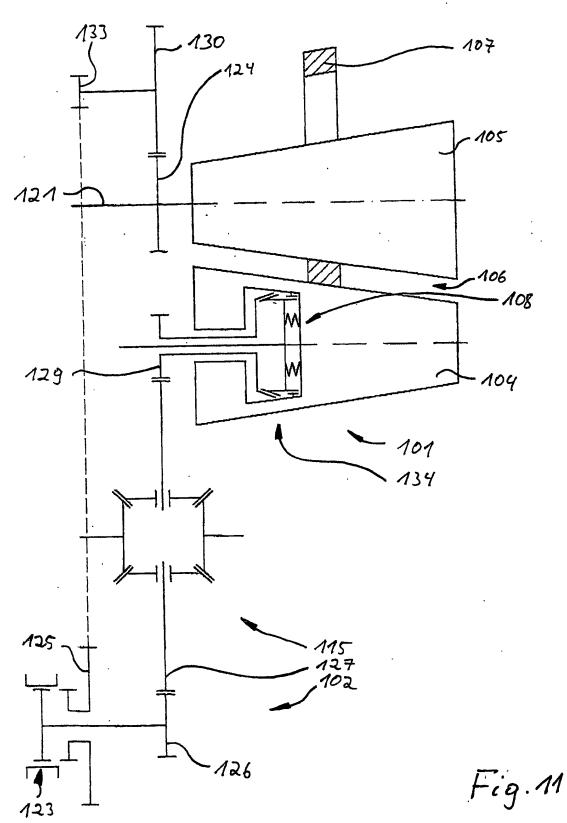
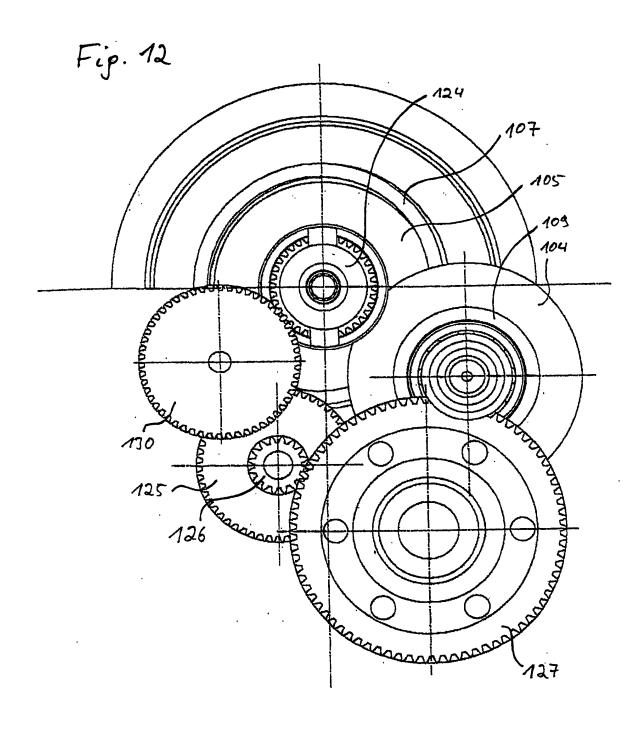
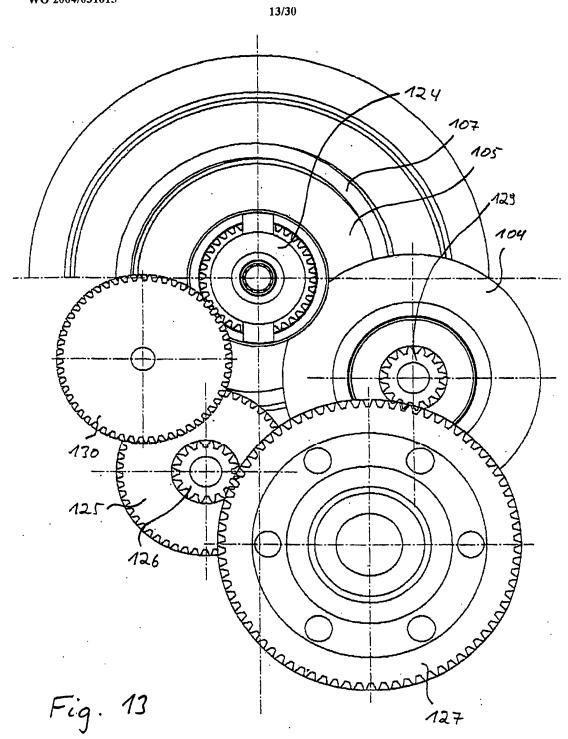


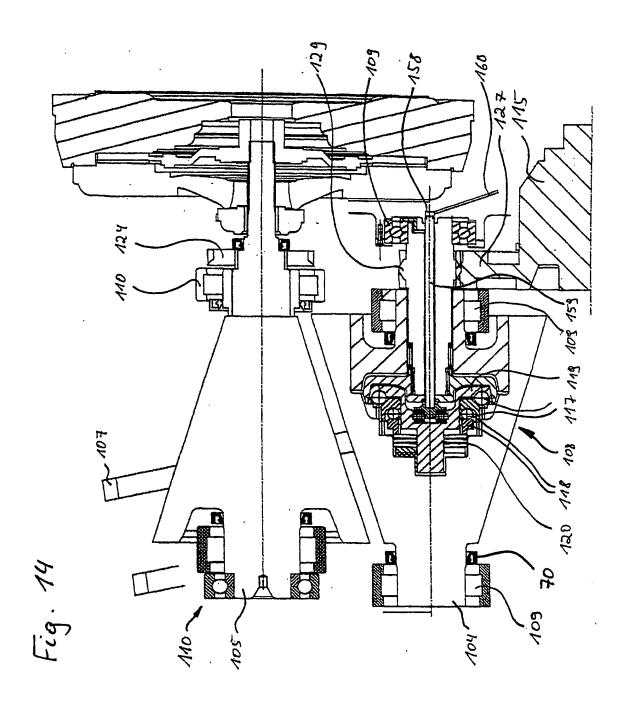
Fig. 10





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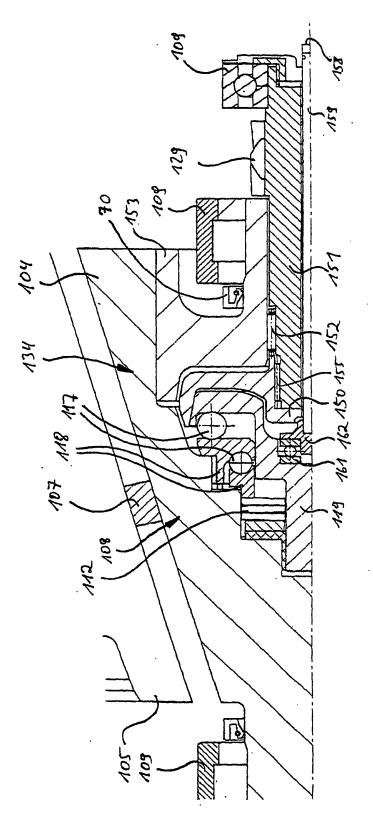


Fig. 15

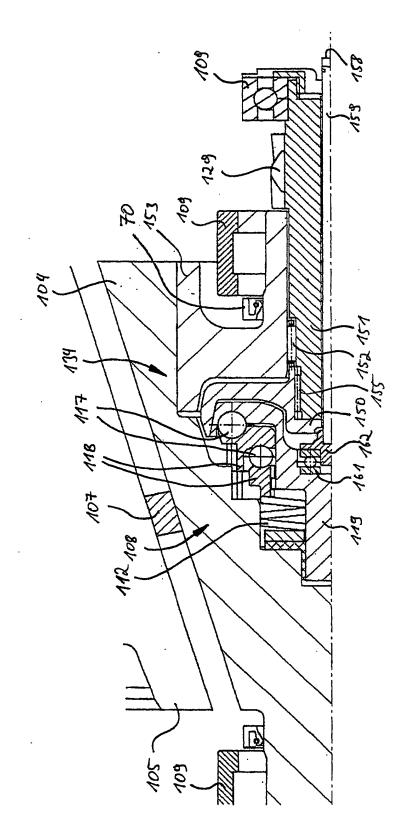


Fig. 1

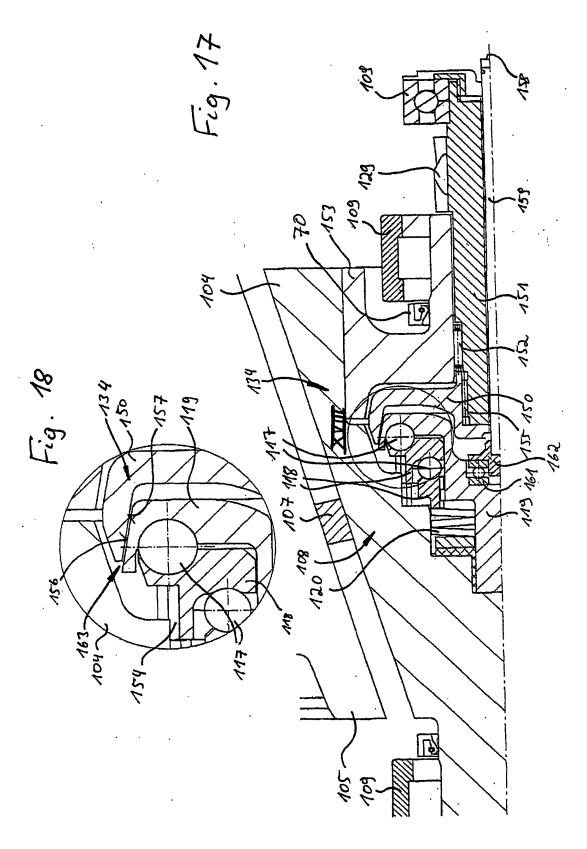
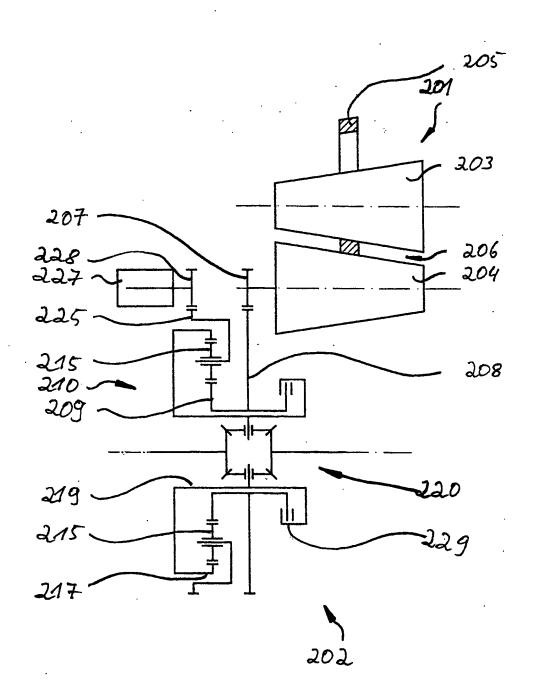
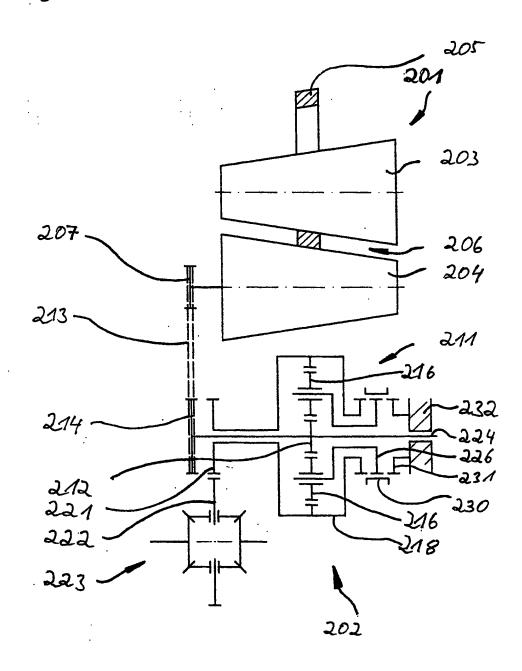


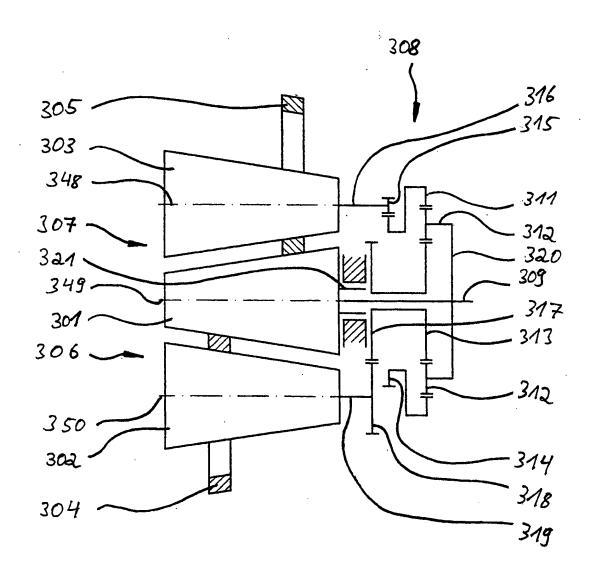
Fig. 19



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Fig. 20





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Fig. 22

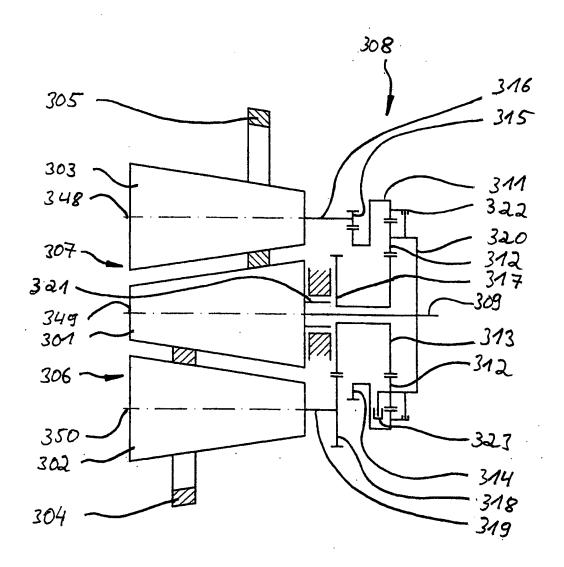
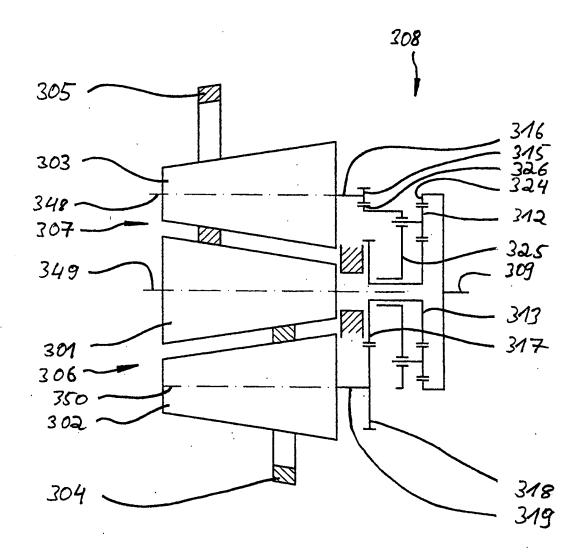
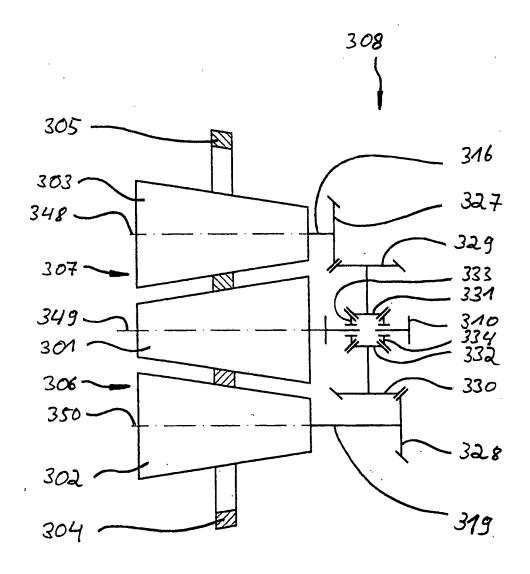


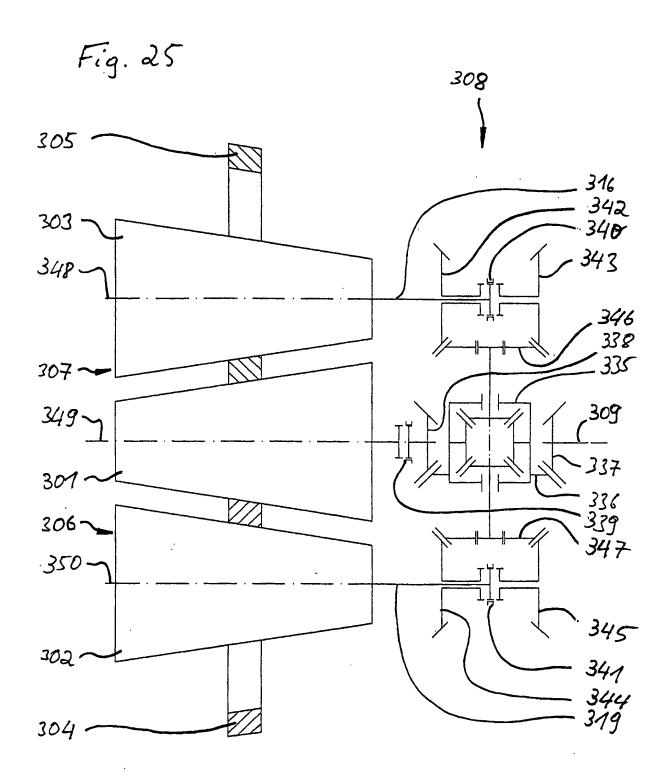
Fig. 23

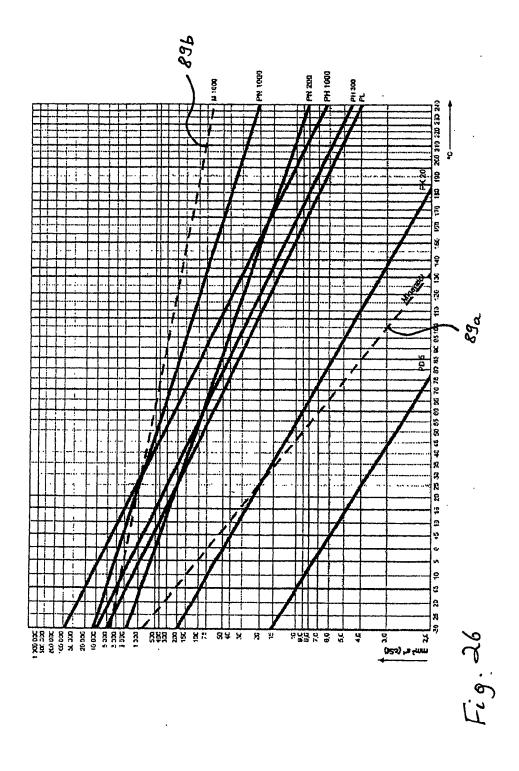


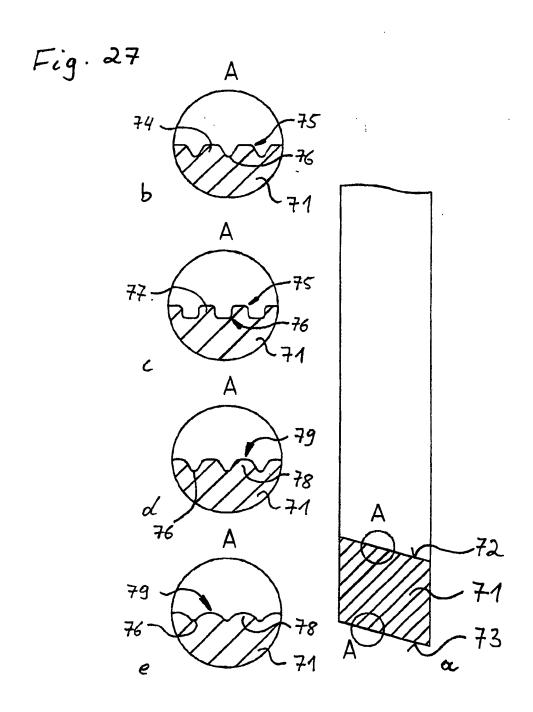
PCT/DE2003/003254

Fig. 24









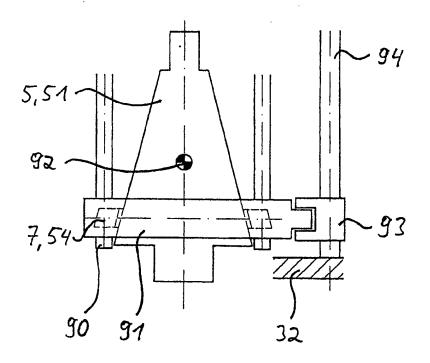


Fig. 28

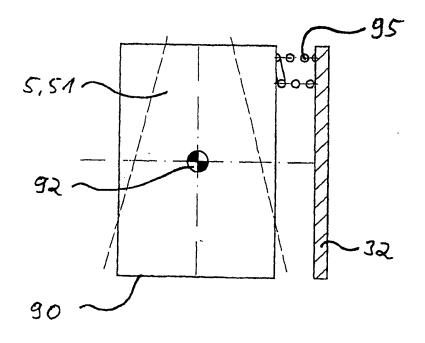


Fig. 29

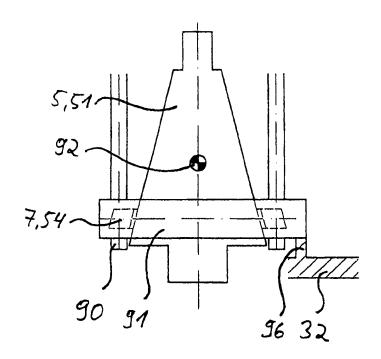


Fig. 30

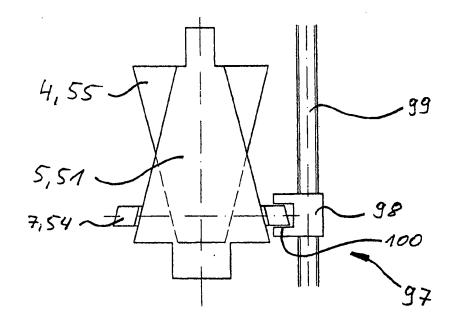


Fig. 31